

NPN 400mA 20V Digital Transistor (Bias Resistor Builtin Transistor) For Muting. Datasheet

Parameter	DTr1 and DTr2		
V _{CEO}	20V		
I _C	400mA		
R ₁	2.2kΩ		

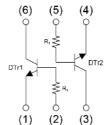
Outline SOT-363 SC-88 UMT6

Features

- 1) Built-In Biasing Resistor, $R_1 = 2.2k\Omega$
- 2) Two DTC923TUB chips in one package.
- 4) Low Output ON Resistance. R_{ON} is Typ. 0.6Ω at V_I =5V
- 5) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).

•Inner circuit

- (1) DTr1 Emitter
- (2) DTr1 Base
- (3) DTr2 Collector
- (4) DTr2 Emitter (5) DTr2 Base
- (6) DTr1 Collector



Application

MUTING

Packaging specifications

9 9 1							
Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
UMH33N	SOT-363 (UMT6)	2021	TR	180	8	3000	H33

Notice

This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.

● Absolute maximum ratings (T_a = 25°C)

<For DTr1 and DTr2 in common>

Parameter	Symbol	Values	Unit
Collector-base voltage	V_{CBO}	40	V
Collector-emitter voltage	V_{CEO}	20	V
Emitter-base voltage	V_{EBO}	40	V
Collector current	I _C	400	mA
Power dissipation	P _D *1*2	150	mW/Total
Junction temperature	T _j	150	°C
Range of storage temperature	T _{stg}	-55 to +150	°C

● Electrical characteristics (T_a = 25°C)

<For DTr1 and DTr2 in common>

Parameter	Cumbal	Conditions	Values			Lloit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Collector-base breakdown voltage	BV _{CBO}	I _C = 50μA	40	-	-	V	
Collector-emitter breakdown voltage	BV _{CEO}	I _C = 1mA	20	-	-	V	
Emitter-base breakdown voltage	BV_{EBO}	I _E = 50μA	40	-	-	V	
Collector cut-off current	I _{CBO}	V _{CB} = 40V	-	-	500	nA	
Emitter cut-off current	I _{EBO}	V _{EB} = 40V	-	-	500	nA	
Collector-emitter saturation voltage	V _{CE(sat)}	I _C = 30mA, I _B = 3mA	-	30	100	mV	
DC current gain	h _{FE}	V_{CE} = 5V, I_{C} = 10mA	820	1	2700	-	
Transition frequency	f _T *3	$V_{CE} = 6V$, $I_{E} = -4mA$, $f = 10MHz$	-	35	-	MHz	
Input resistance	R ₁	-	1.54	2.2	2.86	kΩ	
Output on resistance	R _{on}	$V_i = 5V$, $R_L = 1k\Omega$, $f = 1kHz$ (See test circuit)	-	0.6	-	Ω	

^{*1} Each terminal mounted on a reference land.

^{*2 120}mW per element must not be exceeded.

^{*3} Characteristics of built-in transistor

● Electrical characteristic curves (T_a = 25°C)

<For DTr1 and DTr2 in common>

Fig.1 Grounded emitter propagation characteristics

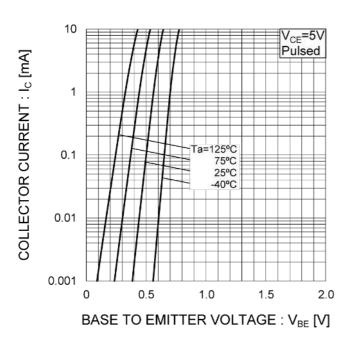
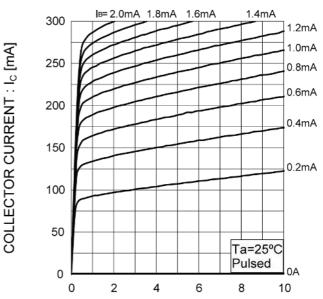


Fig.2 Grounded emitter output characteristics



COLLECTOR TO EMITTER VOLTAGE: V_{CE} [V]

Fig.3 DC Current gain vs. Collector Current

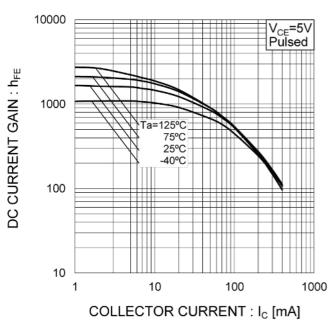
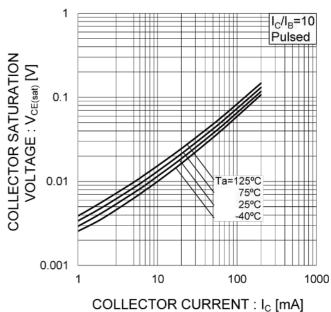


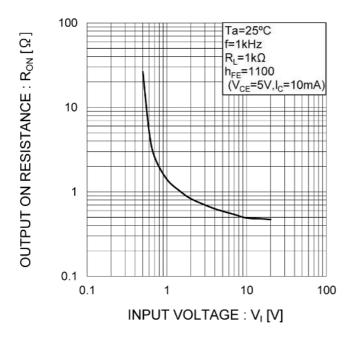
Fig.4 Collector-emitter saturation voltage vs. Collector Current



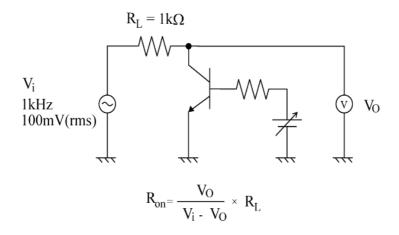
● Electrical characteristic curves (T_a = 25°C)

<For DTr1 and DTr2 in common>

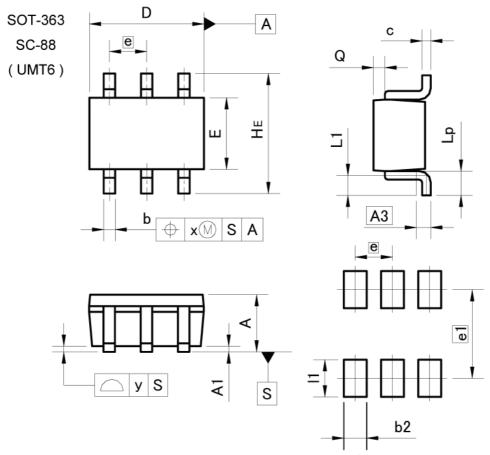
Fig.5 Output ON resistance vs. input voltage



Ron MEASUREMENT CIRCUIT



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM -	MILIM	ETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	0.80	1.00	0.031	0.039	
A1	0.00	0.10	0.000	0.004	
A3	0.3	25	0.010		
b	0.15	0.30	0.006	0.012	
С	0.10	0.20	0.004	0.008	
D	1.90	2.10	0.075	0.083	
E	1.15	1.35	0.045	0.053	
е	0.	65	0.026		
HE	2.00	2.20	0.079	0.087	
L1	0.10	0.40	0.004	0.016	
Lp	0.25	0.55	0.010	0.022	
Q	0.10	0.30	0.004	0.012	
х	-8	0.10	(-	0.004	
у	=8	0.10	3 	0.004	
DIM	MILIMETERS		INC	HES	
	MIN	MAX	MIN	MAX	
b2	=:	0.40	0 	0.016	

Dimension in mm/inches

11

0.026

0.65

Notice

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JAPAN	USA	EU	CHINA
CLASSⅢ	CL ACCIII	CLASSIIb	CL ACCTI
CLASSIV	CLASSII	CLASSⅢ	CLASSIII

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 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

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- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
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- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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